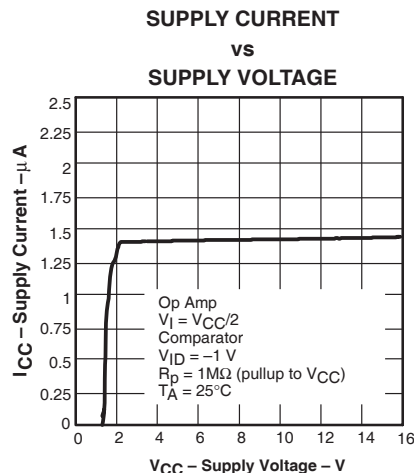
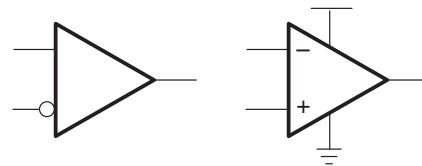


# TLV2302, TLV2304

## FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

- **Micro-Power Operation . . . 1.4  $\mu$ A**
- **Input Common-Mode Range Exceeds the Rails . . .  $-0.1$  V to  $V_{CC} + 5$  V**
- **Supply Voltage Range . . . 2.5 V to 16 V**
- **Rail-to-Rail Input/Output (Amplifier)**
- **Reverse Battery Protection Up to 18 V**
- **Gain Bandwidth Product . . . 5.5 kHz (Amplifier)**
- **Open-Drain CMOS Output Stage (Comparator)**
- **Specified Temperature Range**  
–  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$  . . . Industrial Grade
- **Ultrasmall Packaging**  
– 8-Pin MSOP (TLV2302)
- **Universal Op-Amp EVM (See the SLOU060 for More Information)**



The TLV230x combines sub-micropower operational amplifier and comparator into a single package that produces excellent micropower signal conditioning with only 1.4  $\mu$ A of supply current. This combination gives the designer more board space and reduces part counts in systems that require an operational amplifier and comparator. The low supply current makes it an ideal choice for battery-powered portable applications where quiescent current is the primary concern. Reverse battery protection guards the amplifier from an over-current condition due to improper battery installation. For harsh environments, the inputs can be taken 5 V above the positive supply rail without damage to the device.

The TLV230x's low supply current is coupled with extremely low input bias currents enabling them to be used with mega-ohm resistors making them ideal for portable, long active life, applications. DC accuracy is ensured with a low typical offset voltage as low as 390  $\mu$ V, CMRR of 90 dB and minimum open loop gain of 130 V/mV at 2.7 V.

The maximum recommended supply voltage is as high as 16 V and ensured operation down to 2.5 V, with electrical characteristics specified at 2.7 V, 5 V, and 15 V. The 2.5-V operation makes it compatible with Li-Ion battery-powered systems and many micropower microcontrollers available today including TI's MSP430.

All members are available in PDIP and SOIC with the duals (one op-amp and one comparator) in the small MSOP package, and the quads (two operational amplifiers and two comparators) in the TSSOP package.

### A SELECTION OF OUTPUT COMPARATORS†

DEVICE	$V_{CC}$ (V)	$V_{IO}$ ( $\mu$ V)	$I_{CC}/\text{Ch}$ ( $\mu$ A)	GBW (kHz)	SR (V/ $\mu$ s)	$t_{PLH}$ ( $\mu$ s)	$t_{PHL}$ ( $\mu$ s)	$t_f$ ( $\mu$ s)	RAIL-TO-RAIL	OUTPUT STAGE
TLV230x	2.5 – 16	390	1.4‡	5.5	0.0025	55	30	5	I/O	OD
TLV270x	2.5 – 16	390	1.4‡	5.5	0.0025	55	30	5	I/O	PP
TLV240x	2.5 – 16	390	880	5.5	0.0025	—	—	—	I/O	—
TLV224x	2.5 – 12	600	1	5.5	0.002	—	—	—	I/O	—
TLV340x	2.5 – 16	250	0.47	—	—	55	30	5	I	OD
TLV370x	2.5 – 16	250	0.47	—	—	55	30	5	I	PP

† All specifications are typical values measured at 5 V.

‡  $I_{CC}$  is specified as one op-amp and one comparator.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2000, Texas Instruments Incorporated

# TLV2302, TLV2304 FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

## TLV2302 AVAILABLE OPTIONS

T <sub>A</sub>	V <sub>IO</sub> max AT 25°C	PACKAGED DEVICES			
		SMALL OUTLINE† (D)	MSOP		PLASTIC DIP (P)
			MSOP† (DGK)	SYMBOLS	
-40°C to 125°C	4000 μV	TLV2302ID	TLV2302IDGK	xxTIAQG	TLV2302IP

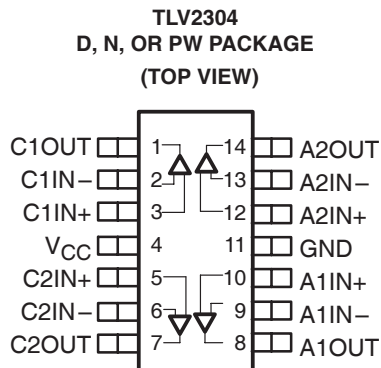
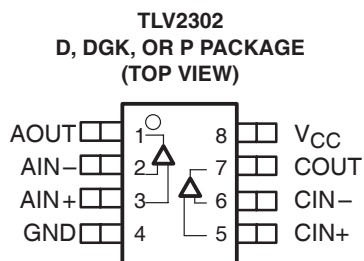
† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2302IDR).

## TLV2304 AVAILABLE OPTIONS

T <sub>A</sub>	V <sub>IO</sub> max AT 25°C	PACKAGED DEVICES		
		SMALL OUTLINE† (D)	TSSOP (PW)	PLASTIC DIP (N)
-40°C to 125°C	4000 μV	TLV2304ID	TLV2304IPW	TLV2304IN

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2304IDR).

## TLV230x PACKAGE PINOUTS



TLV2302, TLV2304  
**FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS  
AND OPEN DRAIN COMPARATORS**

SLOS343 – DECEMBER 2000

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{CC}$ (see Note 1)	17 V
Differential input voltage, $V_{ID}$	$V_{CC}$
Input voltage range, $V_I$ (see Notes 1 and 2)	0 to $V_{CC} + 5$ V
Input current range, $I_I$ (any input)	$\pm 10$ mA
Output current range, $I_O$	$\pm 10$ mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ : I suffix	$-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$
Maximum junction temperature, $T_J$	$150^{\circ}\text{C}$
Storage temperature range, $T_{stg}$	$-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	$260^{\circ}\text{C}$

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to GND  
2. Input voltage range is limited to 20 V max or  $V_{CC} + 5$  V, whichever is smaller.

**DISSIPATION RATING TABLE**

PACKAGE	$\Theta_{JC}$ ( $^{\circ}\text{C}/\text{W}$ )	$\Theta_{JA}$ ( $^{\circ}\text{C}/\text{W}$ )	$T_A \leq 25^{\circ}\text{C}$ POWER RATING	$T_A = 125^{\circ}\text{C}$ POWER RATING
D (8)	38.3	176	710 mW	142 mW
D (14)	26.9	122.3	1022 mW	204.4 mW
DGK (8)	54.2	259.9	481 mW	96.2 mW
N (14)	32	78	1600 mW	320.5 mW
P (8)	41	104	1200 mW	240.4 mW
PW (14)	29.3	173.6	720 mW	144 mW

**recommended operating conditions**

		MIN	MAX	UNIT
Supply voltage, $V_{CC}$	Single supply	2.5	16	V
	Split supply	$\pm 1.25$	$\pm 8$	
Common-mode input voltage range, $V_{ICR}$	Amplifier and comparator	-0.1	$V_{CC}+5$	V
Operating free-air temperature, $T_A$		-40	125	$^{\circ}\text{C}$



# TLV2302, TLV2304

## FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted)

### amplifier dc performance

PARAMETER		TEST CONDITIONS	$T_A^\dagger$	MIN	TYP	MAX	UNIT
$V_{IO}$	Input offset voltage	$V_O = V_{CC}/2 \text{ V}$ , $V_{IC} = V_{CC}/2 \text{ V}$ , $R_S = 50 \Omega$	25°C	390	4000		$\mu\text{V}$
			Full range		6000		
$\alpha V_{IO}$	Offset voltage draft		25°C	3			$\mu\text{V}/^\circ\text{C}$
CMRR	Common-mode rejection ratio	$V_{IC} = 0 \text{ to } V_{CC}$ , $R_S = 50 \Omega$	$V_{CC} = 2.7 \text{ V}$	25°C	55	73	dB
				Full range	52		
			$V_{CC} = 5 \text{ V}$	25°C	60	80	
				Full range	55		
			$V_{CC} = 15 \text{ V}$	25°C	66	90	
				Full range	60		
AVD	Large-signal differential voltage amplification	$V_{CC} = 2.7 \text{ V}$ , $V_{O(pp)} = 1.5 \text{ V}$ , $R_L = 500 \text{ k}\Omega$	25°C	130	400	V/mV	
			Full range	30			
			$V_{CC} = 5 \text{ V}$ , $V_{O(pp)} = 3 \text{ V}$ , $R_L = 500 \text{ k}\Omega$	25°C	300		1000
				Full range	100		
			$V_{CC} = 15 \text{ V}$ , $V_{O(pp)} = 8 \text{ V}$ , $R_L = 500 \text{ k}\Omega$	25°C	400		1400
				Full range	120		
PSRR	Power supply rejection ratio ( $\Delta V_{CC}/\Delta V_{IO}$ )	$V_{IC} = V_{CC}/2 \text{ V}$ , No load	$V_{CC} = 2.7 \text{ to } 5 \text{ V}$	25°C	90	120	dB
				Full range	85		
			$V_{CC} = 5 \text{ to } 15 \text{ V}$	25°C	94	120	
				Full range	90		

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

### amplifier and comparator input characteristics

PARAMETER		TEST CONDITIONS	$T_A^\dagger$	MIN	TYP	MAX	UNIT
$I_{IO}$	Input offset current	$V_O = V_{CC}/2 \text{ V}$ , $V_{IC} = V_{CC}/2 \text{ V}$ , $R_p = 1 \text{ M}\Omega$ (pullup to $V_{CC}$ ), $R_S = 50 \Omega$	25°C		25	250	pA
			0 to $70^\circ\text{C}$			300	
			Full range			500	
$I_{IB}$	Input bias current	$V_O = V_{CC}/2 \text{ V}$ , $V_{IC} = V_{CC}/2 \text{ V}$ , $R_p = 1 \text{ M}\Omega$ (pullup to $V_{CC}$ ), $R_S = 50 \Omega$	25°C		100	500	pA
			0 to $70^\circ\text{C}$			550	
			Full range			1000	
$r_{i(d)}$	Differential input resistance		25°C		300		$\text{M}\Omega$
$C_{i(c)}$	Common-mode input capacitance	$f = 100 \text{ kHz}$	25°C		3		pF

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .



TLV2302, TLV2304  
**FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS  
 AND OPEN DRAIN COMPARATORS**

SLOS343 – DECEMBER 2000

electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted) (continued)

**amplifier output characteristics**

PARAMETER		TEST CONDITIONS	$T_A^\dagger$	MIN	TYP	MAX	UNIT
$V_{OH}$	High-level output voltage	$V_{IC} = V_{CC}/2$ , $I_{OH} = -50 \mu\text{A}$	25°C	2.55		2.65	V
				Full range	2.5		
			25°C	4.85		4.95	
				Full range	4.8		
			25°C	14.85		14.95	
				Full range	14.8		
$V_{OL}$	Low-level output voltage	$V_{IC} = V_{CC}/2$ , $I_{OL} = 50 \mu\text{A}$	25°C	180	260	mV	
			Full range	300			
$I_O$	Output current	$V_O = 0.5 \text{ V}$ from rail	25°C	$\pm 200$		$\mu\text{A}$	

† Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

**amplifier dynamic performance**

PARAMETER		TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT
UGBW	Unity gain bandwidth	$R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$	25°C	5.5			kHz
SR	Slew rate at unity gain	$V_{O(pp)} = 0.8 \text{ V}$ , $R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$	25°C	2.5			V/ms
$\phi_M$	Phase margin	$R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$	25°C	60°			
	Gain margin			15			dB
$t_s$	Settling time	$V_{CC} = 2.7 \text{ or } 5 \text{ V}$ , $V(\text{STEP})_{PP} = 1 \text{ V}$ , $A_V = -1$ , $C_L = 100 \text{ pF}$ , $R_L = 100 \text{ k}\Omega$	25°C	0.1%		1.84	ms
				0.1%		6.1	
				0.01%		32	
$V_n$	Equivalent input noise voltage	$f = 0.1 \text{ to } 10 \text{ Hz}$	25°C	5.3			$\mu\text{V}_{pp}$
				$f = 100 \text{ Hz}$	500		
$I_n$	Equivalent input noise current	$f = 100 \text{ Hz}$	25°C	8			$\text{fA}/\sqrt{\text{Hz}}$

**supply current**

PARAMETER		TEST CONDITIONS	$T_A^\dagger$	MIN	TYP	MAX	UNIT
$I_{CC}$	Supply current (one op-amp and one comparator)	$R_p = \text{No pullup}$ , Output state high	$V_{CC} = 2.7 \text{ V or } 5 \text{ V}$	25°C	1.4		$\mu\text{A}$
			$V_{CC} = 15 \text{ V}$	25°C	1.4	1.7	
				Full range	2.3		
Reverse supply current		$V_{CC} = -18 \text{ V}$ , $V_I = 0 \text{ V}$ , $V_O = \text{open}$	25°C	50			nA

† Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .



# TLV2302, TLV2304

## FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $15 \text{ V}$  (unless otherwise noted) (continued)

### comparator dc performance

PARAMETER		TEST CONDITIONS†	$T_A$ †	MIN	TYP	MAX	UNIT	
$V_{IO}$	Input offset voltage	$V_{IC} = V_{CC}/2$ , $R_S = 50 \Omega$ , $R_P = 1 \text{ M}\Omega$ (pullup to $V_{CC}$ )	25°C	250	5000		$\mu\text{V}$	
			Full range		7000			
$\alpha_{VIO}$	Offset voltage drift		25°C	3			$\mu\text{V}/^\circ\text{C}$	
CMRR	Common-mode rejection ratio	$V_{IC} = 0$ to $V_{CC}$ , $R_S = 50 \Omega$	25°C	$V_{CC} = 2.7 \text{ V}$		55	72	dB
				Full range				
			25°C	$V_{CC} = 5 \text{ V}$		60	76	
				Full range			55	
			25°C	$V_{CC} = 15 \text{ V}$		65	88	
				Full range			60	
AVD	Large-signal differential voltage amplification	$R_P = 1 \text{ M}\Omega$ (pullup to $V_{CC}$ )	25°C	1000			V/mV	
PSRR	Power supply rejection ratio ( $\Delta V_{CC}/\Delta V_{IO}$ )	$V_{IC} = V_{CC}/2 \text{ V}$ , No load	25°C	$V_{CC} = 2.7$ to $5 \text{ V}$		75	100	dB
				Full range			70	
			25°C	$V_{CC} = 5$ to $15 \text{ V}$		85	105	
				Full range			80	

† Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

### comparator output characteristics

PARAMETER		TEST CONDITIONS†	$T_A$ †	MIN	TYP	MAX	UNIT
$I_{OZ}$	High-impedance output leakage current	$V_{IC} = V_{CC}/2$ , $V_O = V_{CC}$ , $V_{ID} = 1 \text{ V}$	25°C		50		pA
$V_{OL}$	Low-level output voltage	$V_{IC} = V_{CC}/2$ , $I_{OL} = 50 \mu\text{A}$ , $V_{ID} = -1 \text{ V}$	25°C		80	200	mV
			Full range			300	

† Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

switching characteristics at recommended operating conditions,  $V_{CC} = 2.7 \text{ V}$ ,  $5 \text{ V}$ ,  $15 \text{ V}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT
$t_{(PLH)}$	Propagation delay time, low-to-high-level output	$f = 10 \text{ kHz}$ , $V_{STEP} = 1 \text{ V}$ , $C_L = 10 \text{ pF}$ , $R_P = 1 \text{ M}\Omega$ (pullup to $V_{CC}$ )	25°C	Overdrive = 2 mV		175	$\mu\text{s}$
				Overdrive = 10 mV		55	
				Overdrive = 50 mV		25	
$t_{(PHL)}$	Propagation delay time, high-to-low-level output		25°C	Overdrive = 2 mV		300	
				Overdrive = 10 mV		60	
				Overdrive = 50 mV		30	
$t_f$	Fall time	$C_L = 10 \text{ pF}$	25°C		5		$\mu\text{s}$

NOTE: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



**TYPICAL CHARACTERISTICS**

**Table of Graphs**

			<b>FIGURE</b>
$V_{IO}$	Input offset voltage	vs Common-mode input voltage	1, 2
$I_{IB}$	Input bias current	vs Free-air temperature	3, 5, 7
		vs Common-mode input voltage	4, 6
$I_{IO}$	Input offset current	vs Free-air temperature	3, 5, 7
		vs Common-mode input voltage	4, 6
$I_{CC}$	Supply current	vs Supply voltage	8
		vs Free-air temperature	9
<b>Amplifier</b>			
CMRR	Common-mode rejection ratio	vs Frequency	10
$V_{OH}$	High-level output voltage	vs High-level output current	11, 13
$V_{OL}$	Low-level output voltage	vs Low-level output current	12, 14
$V_{O(PP)}$	Output voltage, peak-to-peak	vs Frequency	15
PSRR	Power supply rejection ratio	vs Frequency	16
	Voltage noise over a 10 Second Period		17
$\phi_m$	Phase margin	vs Capacitive load	18
$A_{VD}$	Differential voltage gain	vs Frequency	19
	Phase	vs Frequency	19
	Gain bandwidth product	vs Supply voltage	20
SR	Slew rate	vs Free-air temperature	21
	Large signal follower pulse response		22
	Small signal follower pulse response		23
	Large signal inverting pulse response		24
	Small signal inverting pulse response		25
<b>Comparator</b>			
$V_{OL}$	Low-level output voltage	vs Low-level output current	26, 27
	Open collector leakage current	vs Free-air temperature	28
	Output fall time	vs Supply voltage	29
	Low-to-high level output response for various input overdrives		30, 31
	High-to-low level output response for various input overdrives		32, 33

# TLV2302, TLV2304 FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

## AMPLIFIER AND COMPARATOR TYPICAL CHARACTERISTICS

**INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT  
VOLTAGE**

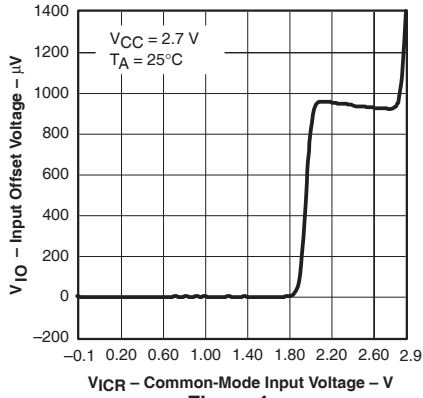


Figure 1

**INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT  
VOLTAGE**

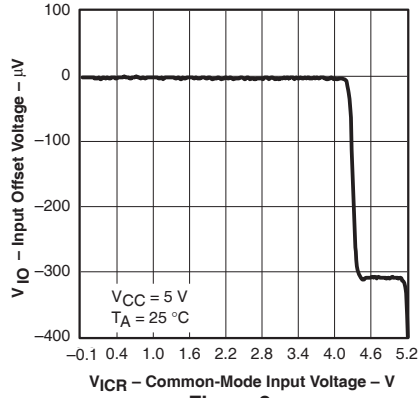


Figure 2

**INPUT BIAS / OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE**

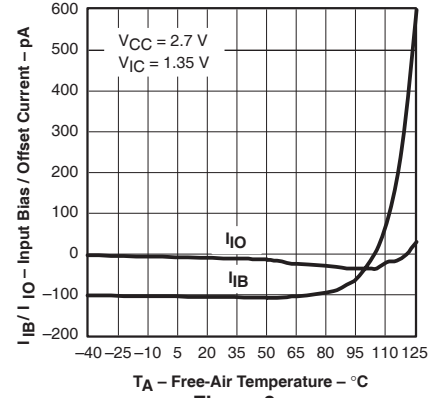


Figure 3

**INPUT BIAS/OFFSET CURRENT  
vs  
COMMON-MODE INPUT  
VOLTAGE**

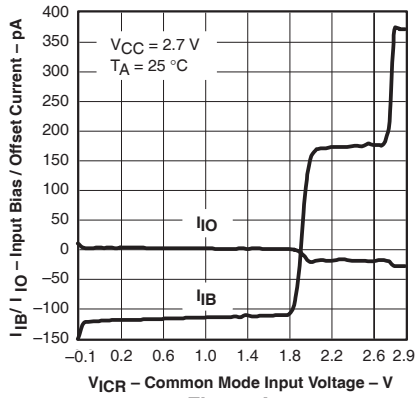


Figure 4

**INPUT BIAS/OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE**

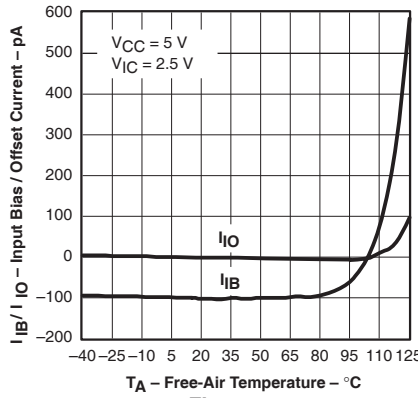


Figure 5

**INPUT BIAS/OFFSET CURRENT  
vs  
COMMON-MODE INPUT  
VOLTAGE**

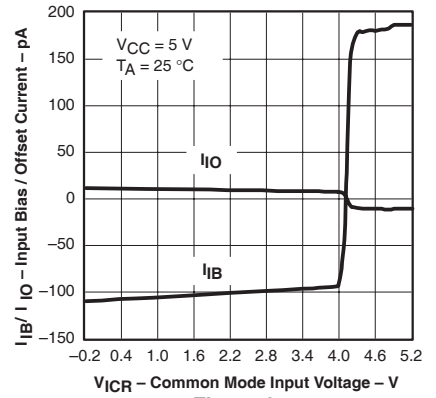


Figure 6

**INPUT BIAS/OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE**

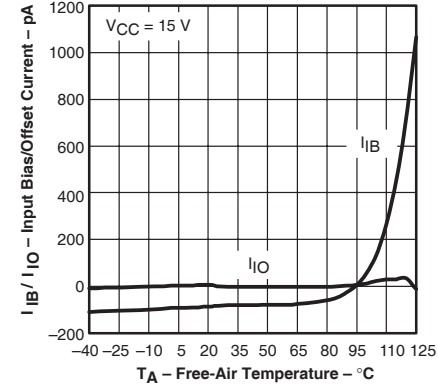


Figure 7

**SUPPLY CURRENT  
vs  
SUPPLY VOLTAGE**

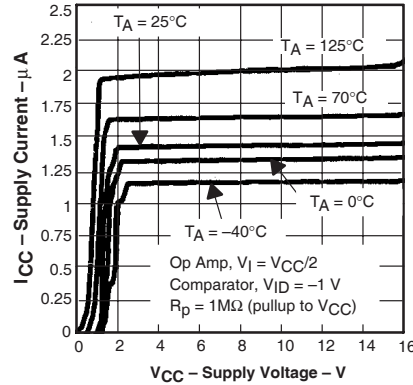


Figure 8

**SUPPLY CURRENT  
vs  
FREE-AIR TEMPERATURE**

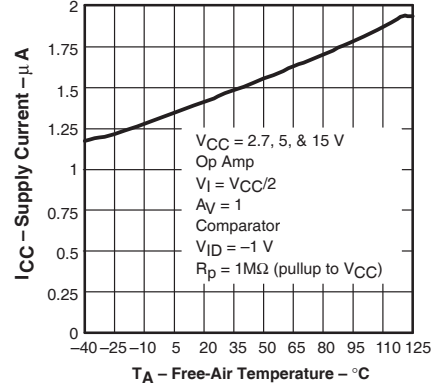


Figure 9





AMPLIFIER TYPICAL CHARACTERISTICS

COMMON-MODE REJECTION RATIO  
 vs  
 FREQUENCY

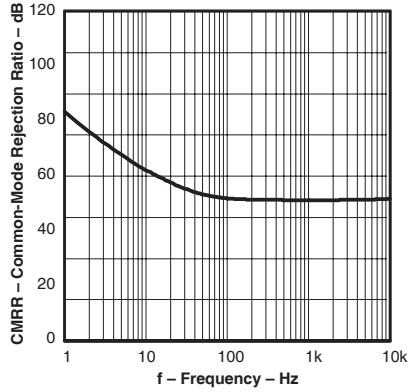


Figure 10

HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT

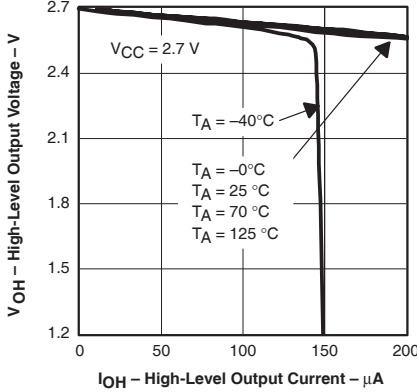


Figure 11

LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT

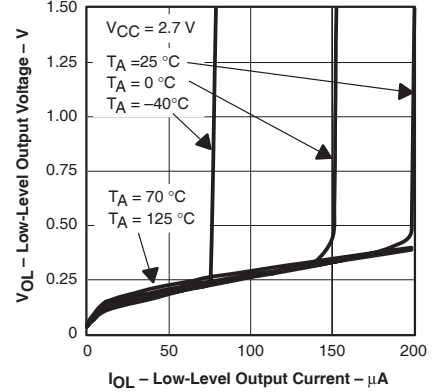


Figure 12

HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT

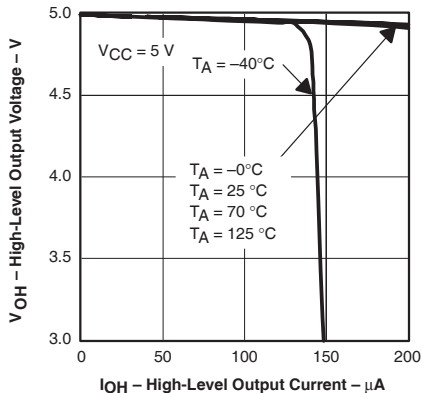


Figure 13

LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT

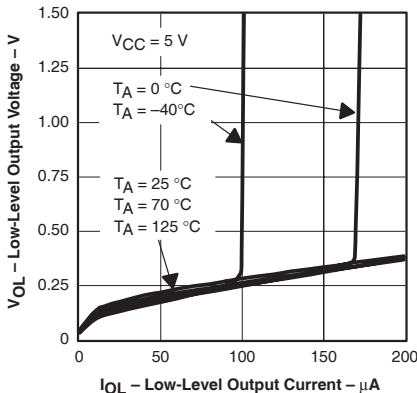


Figure 14

OUTPUT VOLTAGE  
 PEAK-TO-PEAK  
 vs  
 FREQUENCY

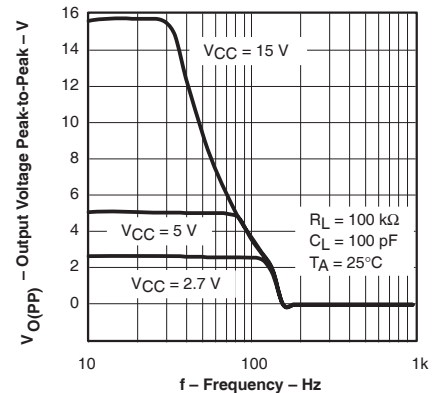


Figure 15

POWER SUPPLY REJECTION RATIO  
 vs  
 FREQUENCY

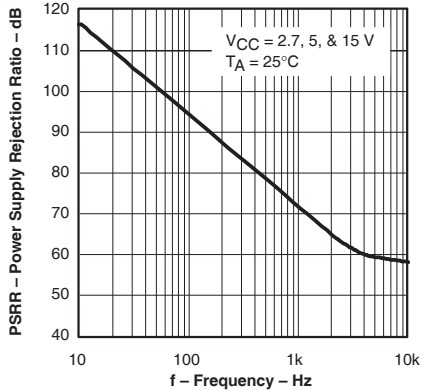


Figure 16

VOLTAGE NOISE  
 OVER A 10 SECOND PERIOD

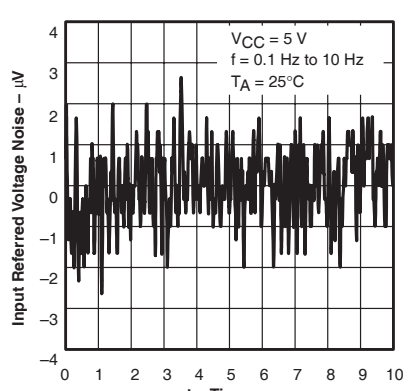


Figure 17

PHASE MARGIN  
 vs  
 CAPACITIVE LOAD

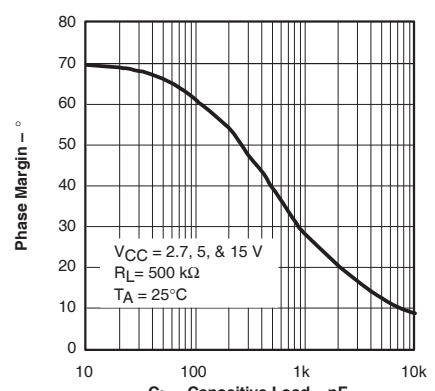


Figure 18

# TLV2302, TLV2304 FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

## AMPLIFIER TYPICAL CHARACTERISTICS

**DIFFERENTIAL VOLTAGE GAIN AND PHASE  
vs  
FREQUENCY**

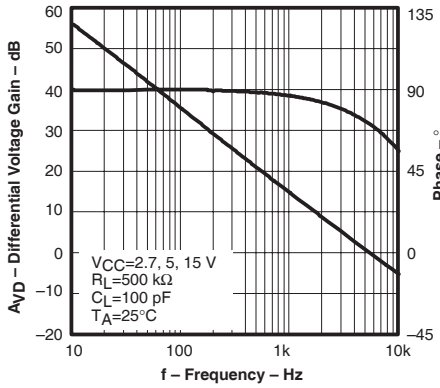


Figure 19

**GAIN BANDWIDTH PRODUCT  
vs  
SUPPLY VOLTAGE**

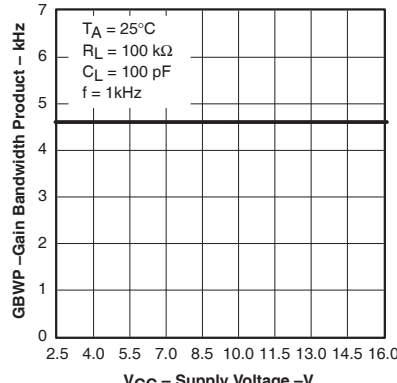


Figure 20

**SLEW RATE  
vs  
FREE-AIR TEMPERATURE**

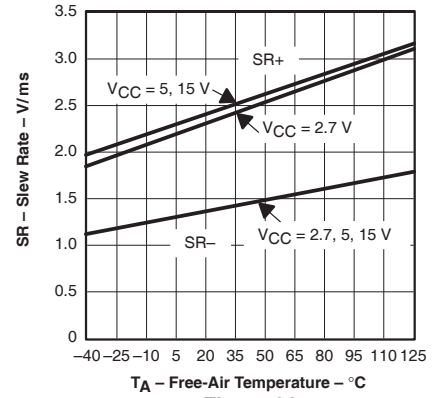


Figure 21

**LARGE SIGNAL FOLLOWER  
PULSE RESPONSE**

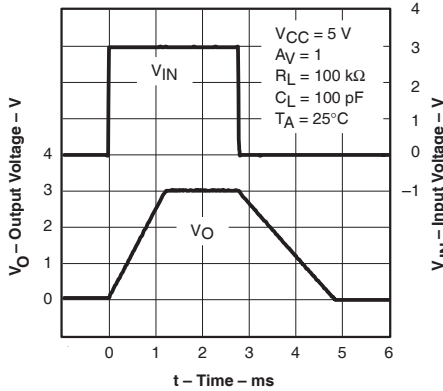


Figure 22

**SMALL SIGNAL FOLLOWER  
PULSE RESPONSE**

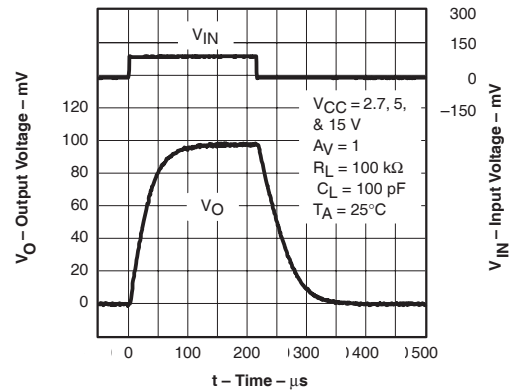


Figure 23

**LARGE SIGNAL INVERTING  
PULSE RESPONSE**

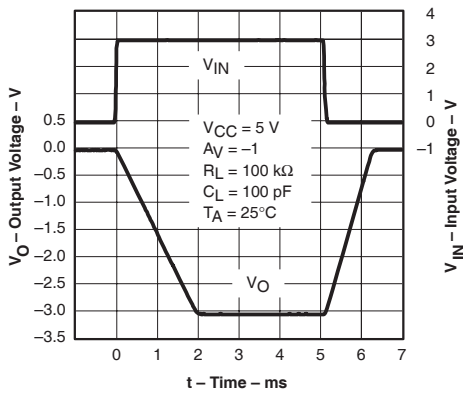


Figure 24

**SMALL SIGNAL INVERTING  
PULSE RESPONSE**

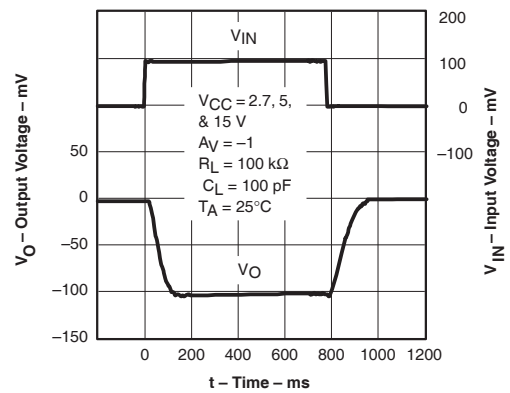


Figure 25

COMPARATOR TYPICAL CHARACTERISTICS

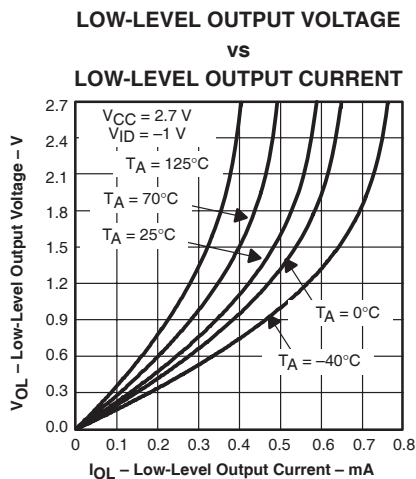


Figure 26

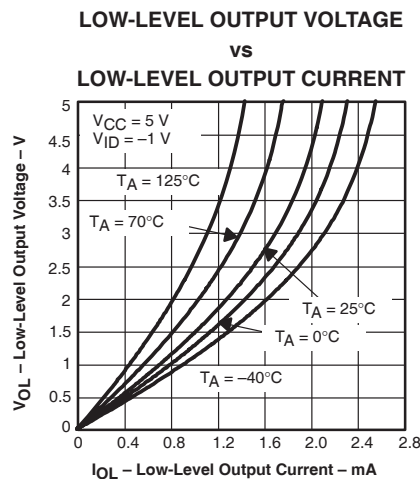


Figure 27

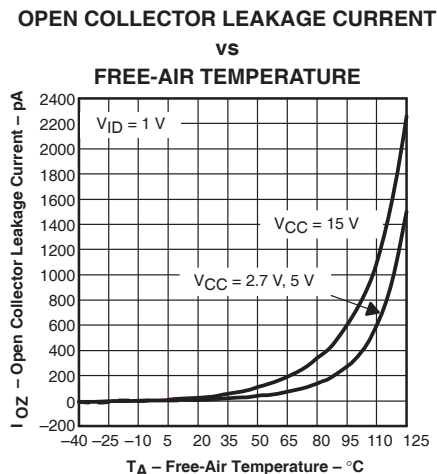


Figure 28

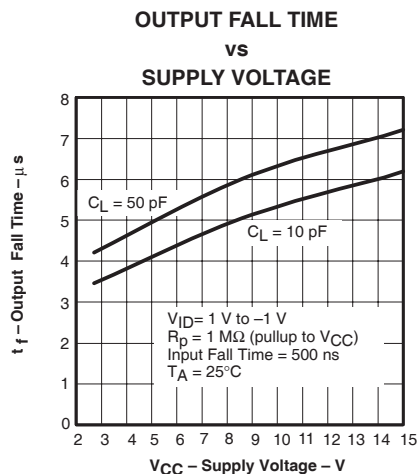


Figure 29

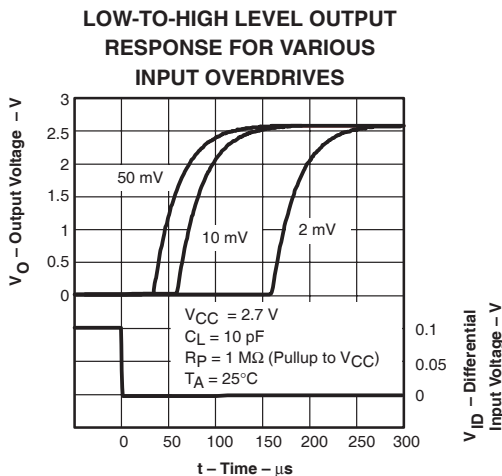


Figure 30

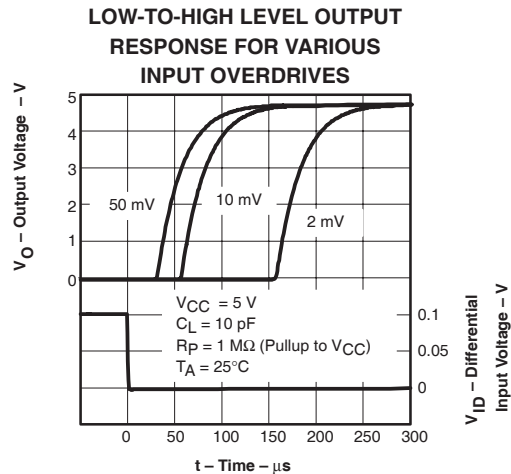


Figure 31

COMPARATOR TYPICAL CHARACTERISTICS

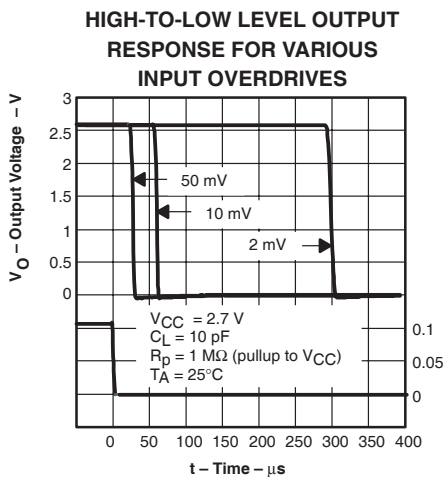


Figure 32

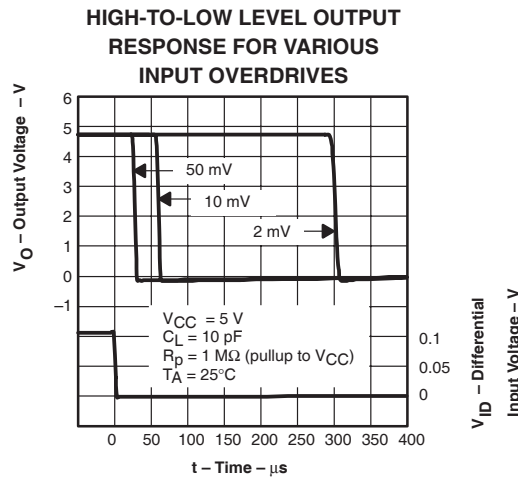


Figure 33

APPLICATION INFORMATION

reverse battery protection

The TLV2302/4 is protected against reverse battery voltage up to 18 V. When subjected to reverse battery condition, the supply current is typically less than 100 nA at 25°C (inputs grounded and outputs open). This current is determined by the leakage of six Schottky diodes and will therefore increase as the ambient temperature increases.

When subjected to reverse battery conditions and negative voltages applied to the inputs or outputs, the input ESD structure will turn on—this current should be limited to less than 10 mA. If the inputs or outputs are referred to ground, rather than midrail, no extra precautions need be taken.

common-mode input range

The TLV2302/4 has rail-rail input and outputs. For common-mode inputs from  $-0.1\text{ V}$  to  $V_{CC} - 0.8\text{ V}$  a PNP differential pair will provide the gain.

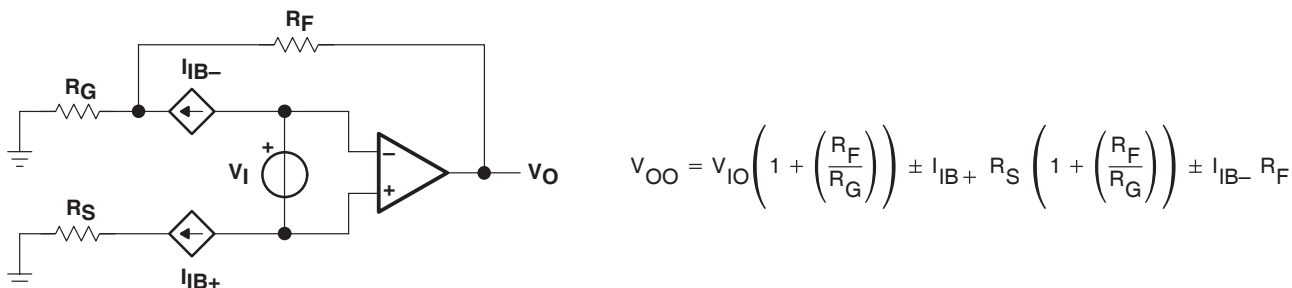
For inputs between  $V_{CC} - 0.8\text{ V}$  and  $V_{CC}$ , two NPN emitter followers buffering a second PNP differential pair provide the gain. This special combination of NPN/PNP differential pair enables the inputs to be taken 5 V above the rails; because as the inputs go above  $V_{CC}$ , the NPNs switch from functioning as transistors to functioning as diodes. This will lead to an increase in input bias current. The second PNP differential pair continues to function normally as the inputs exceed  $V_{CC}$ .

The TLV2302/4 has a negative common-input range that exceeds ground by 100 mV. If the inputs are taken much below this, reduced open loop gain will be observed with the ultimate possibility of phase inversion.

## APPLICATION INFORMATION

### offset voltage

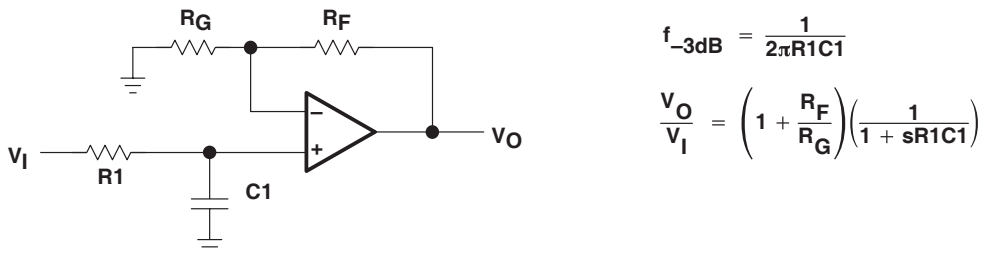
The output offset voltage, ( $V_{OO}$ ) is the sum of the input offset voltage ( $V_{IO}$ ) and both input bias currents ( $I_{IB}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage.



**Figure 34. Output Offset Voltage Model**

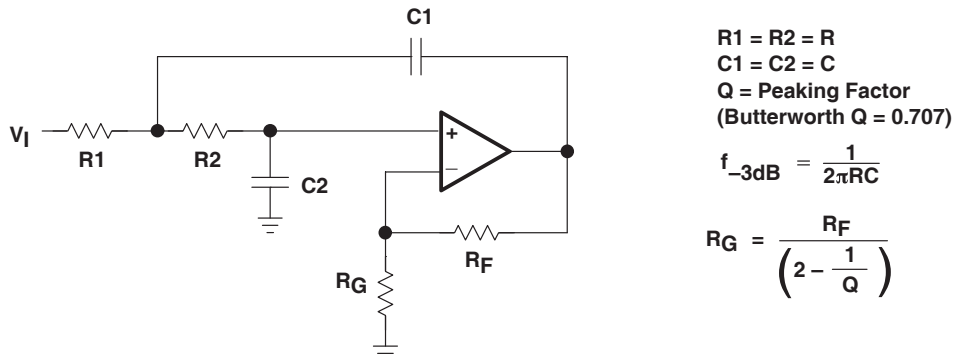
### general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 35).



**Figure 35. Single-Pole Low-Pass Filter**

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.



**Figure 36. 2-Pole Low-Pass Sallen-Key Filter**

## APPLICATION INFORMATION

### circuit layout considerations

To achieve the levels of high performance of the TLV230x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes—It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling—Use a 6.8- $\mu$ F tantalum capacitor in parallel with a 0.1- $\mu$ F ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1- $\mu$ F ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1- $\mu$ F capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets—Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- Short trace runs/compact part placements—Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components—Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.

## APPLICATION INFORMATION

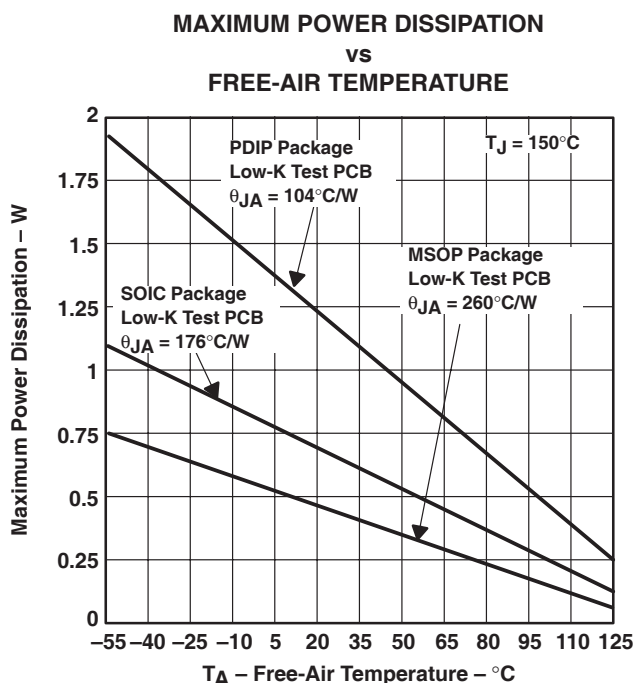
### general power dissipation considerations

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in Figure 37 and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

- $P_D$  = Maximum power dissipation of TLV230x IC (watts)
- $T_{MAX}$  = Absolute maximum junction temperature (150°C)
- $T_A$  = Free-ambient air temperature (°C)
- $\theta_{JA}$  =  $\theta_{JC} + \theta_{CA}$
- $\theta_{JC}$  = Thermal coefficient from junction to case
- $\theta_{CA}$  = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

**Figure 37. Maximum Power Dissipation vs Free-Air Temperature**

# TLV2302, TLV2304 FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND OPEN DRAIN COMPARATORS

SLOS343 – DECEMBER 2000

## APPLICATION INFORMATION

### amplifier macromodel information

Macromodel information provided was derived using Microsim *Parts*™ Release 8, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 2) and subcircuit in Figure 38 are generated using the TLV230x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 3: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

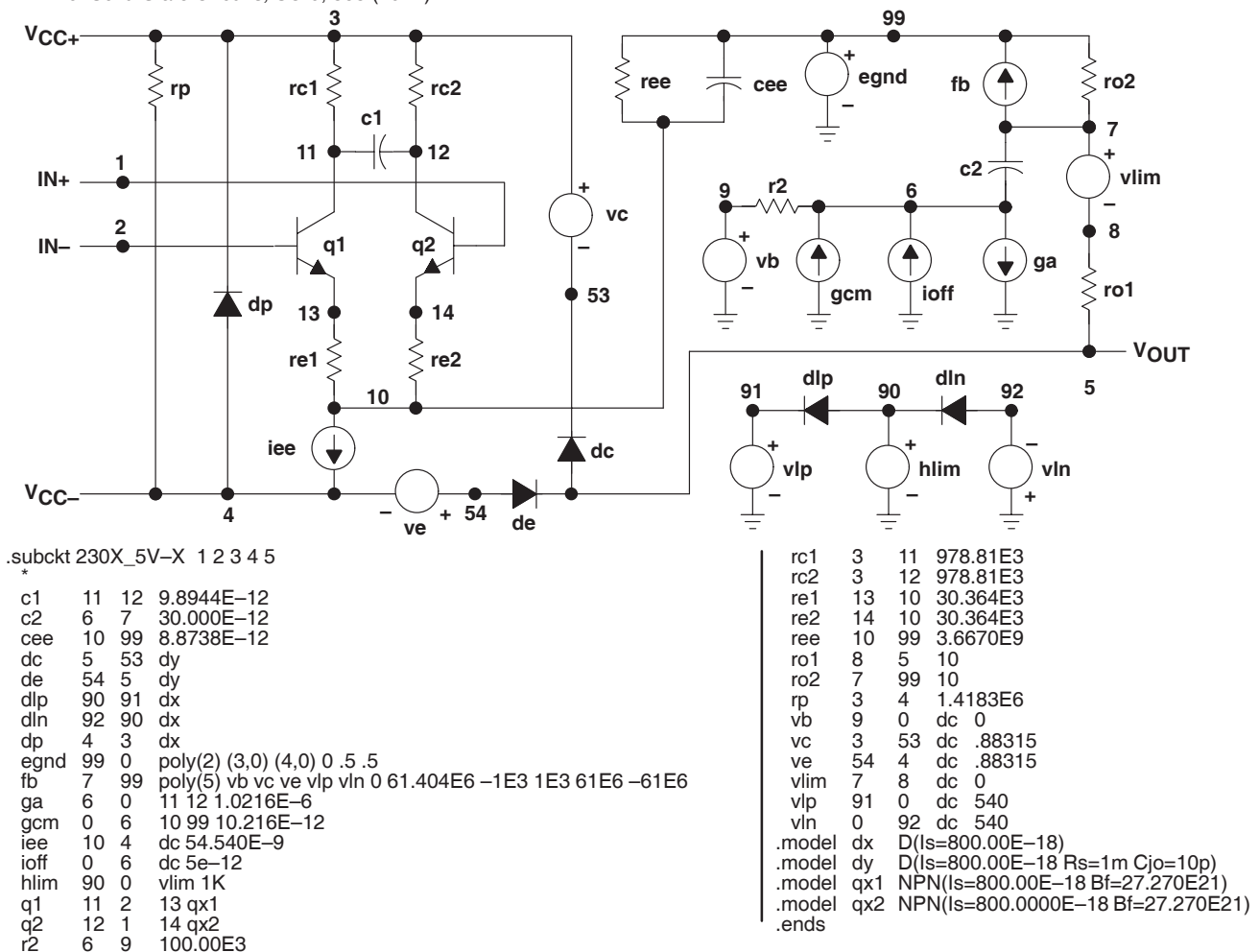


Figure 38. Boyle Macromodels and Subcircuit

*PSpice* and *Parts* are trademarks of MicroSim Corporation.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265



**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TLV2302ID</a>	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2302I
<a href="#">TLV2302IDGK</a>	Active	Production	VSSOP (DGK)   8	80   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AQG
<a href="#">TLV2302IDGKR</a>	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AQG
<a href="#">TLV2302IDR</a>	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2302I
<a href="#">TLV2302IP</a>	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 125	TLV2302I
<a href="#">TLV2304ID</a>	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2304I
<a href="#">TLV2304IDR</a>	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2304I
<a href="#">TLV2304IN</a>	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 125	TLV2304I

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV2302IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
TLV2302IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLV2304IDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV2302IDGKR	VSSOP	DGK	8	2500	358.0	335.0	35.0
TLV2302IDR	SOIC	D	8	2500	340.5	338.1	20.6
TLV2304IDR	SOIC	D	14	2500	340.5	336.1	32.0

**TUBE**


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TLV2302ID	D	SOIC	8	75	507	8	3940	4.32
TLV2302IP	P	PDIP	8	50	506	13.97	11230	4.32
TLV2304ID	D	SOIC	14	50	507	8	3940	4.32
TLV2304IN	N	PDIP	14	25	506	13.97	11230	4.32

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265

Copyright © 2025, Texas Instruments Incorporated